

Ceramic Plate Series Thermoelectric Cooler

The CP2-127-06-L2-EP-W4.5 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum Q_c of 117.8 Watts when $\Delta T = 0$ and a maximum ΔT of 70.5 °C at $Q_c = 0$.

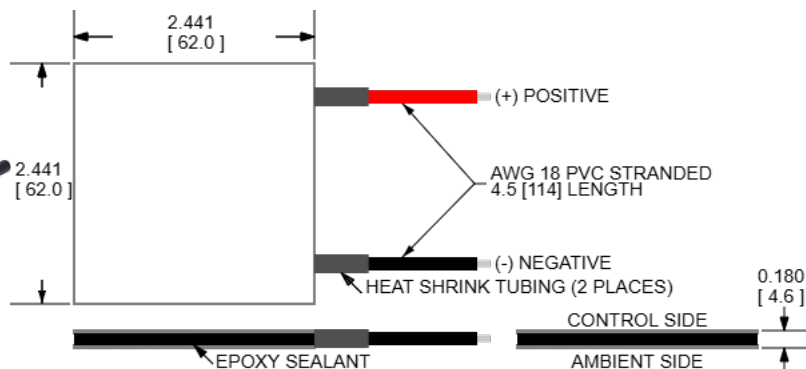


Features

- Compact geometric sizes
- DC Operation
- RoHS-compliant

Applications

- Thermoelectric Coolers for Reagent Storage
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Cooling for Centrifuges
- Peltier Cooling for Machine Vision



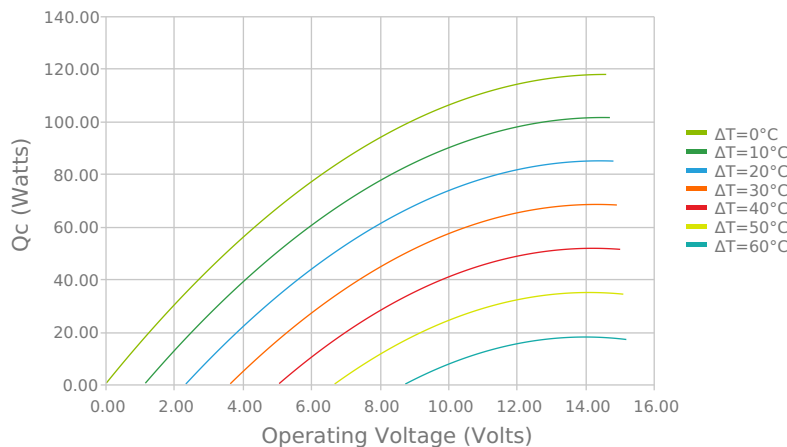
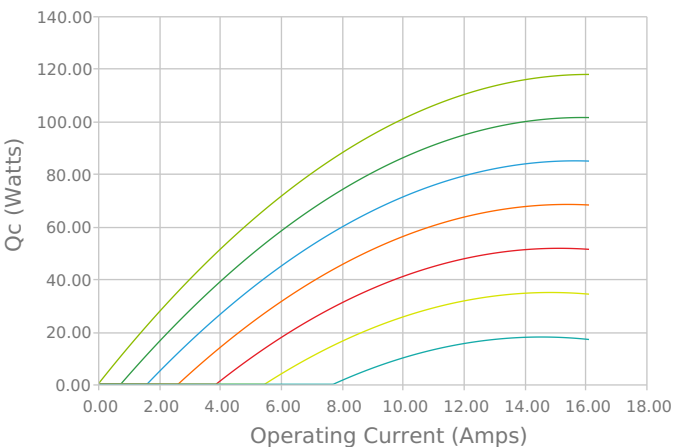
CERAMIC MATERIAL: Al_2O_3
 SOLDER CONSTRUCTION: 138°C, BiSn
 INCHES [MM]
 Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

Electrical and Thermal Performance

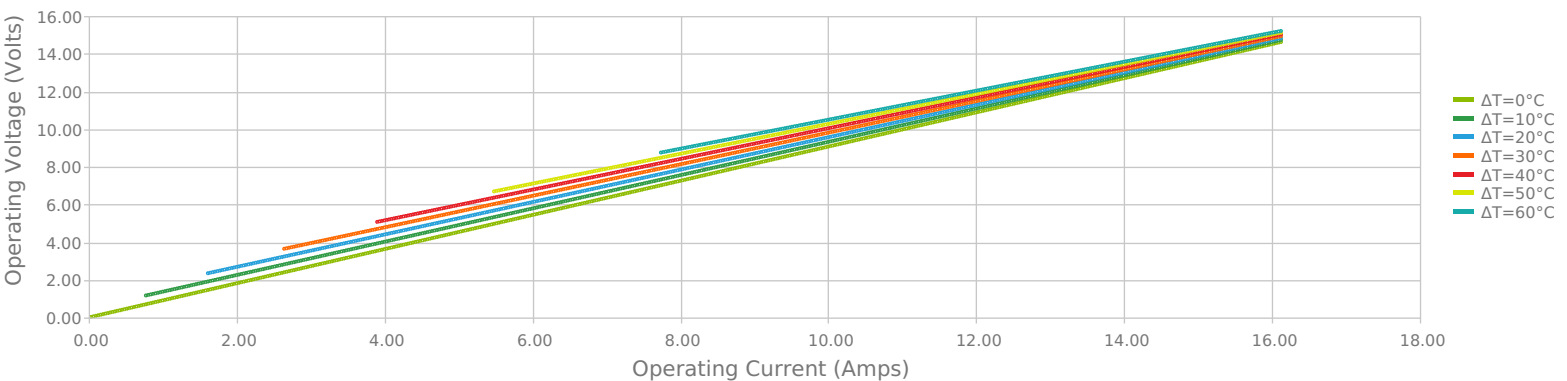
For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the AMBIENT side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.

Heat Pumped at Cold Side
 $Thot = 27\text{ °C}$

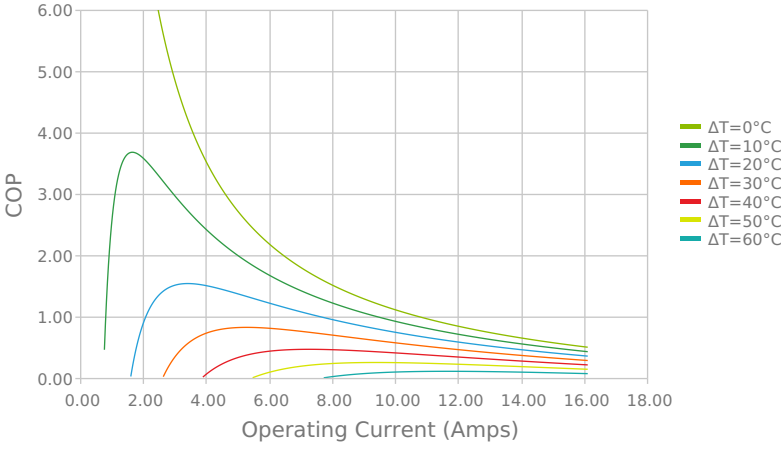
Heat Pumped at Cold Side
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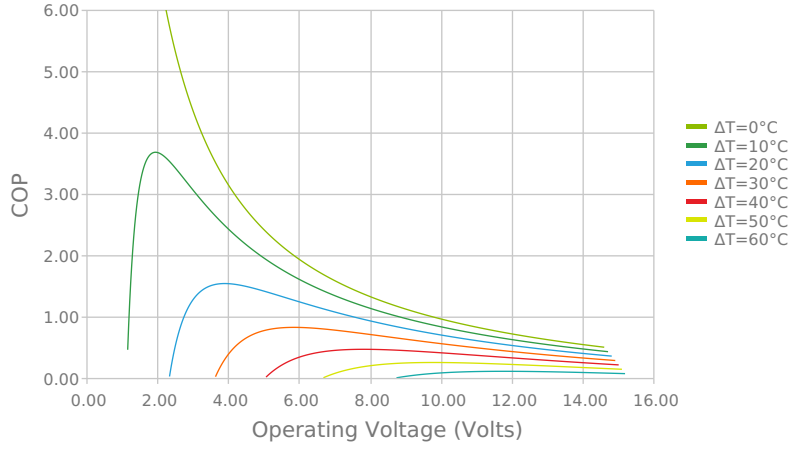
Current vs Voltage (I vs V)
 $Thot = 27\text{ °C}$



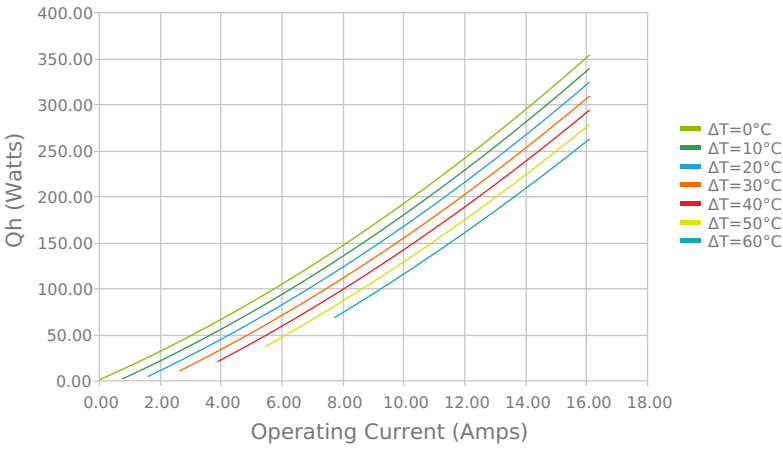
Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 27\text{ }^\circ\text{C}$



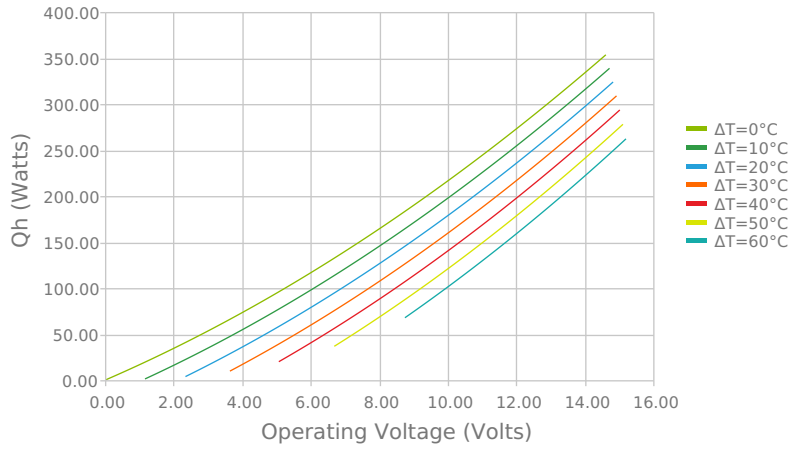
Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 27\text{ }^\circ\text{C}$



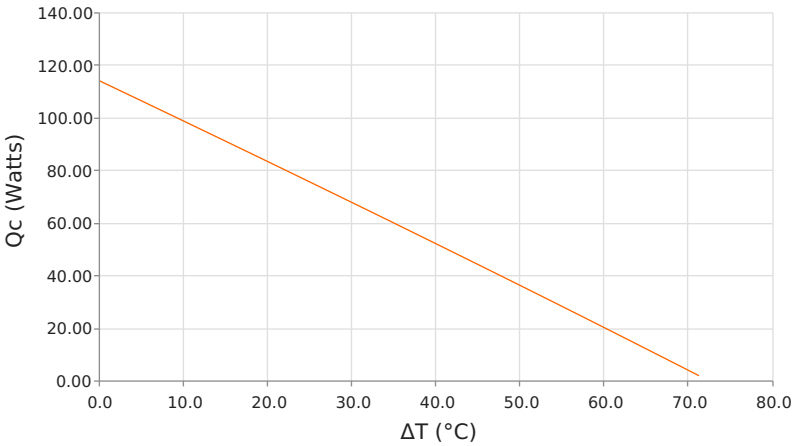
Total Heat Dissipated at Hot Side ($Q_h=Q_c+P_{in}$)
 $T_{hot} = 27\text{ }^\circ\text{C}$



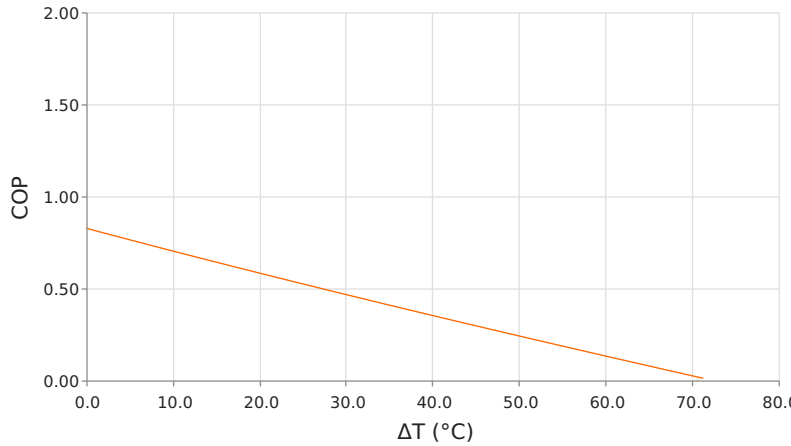
Total Heat Dissipated at Hot Side ($Q_h=Q_c+P_{in}$)
 $T_{hot} = 27\text{ }^\circ\text{C}$



Heat Pumped at Cold Side (Q_c)
 $T_{hot} = 35\text{ }^\circ\text{C}$ | $i_{operating} = 12.1\text{ Amps}$



Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 35\text{ }^\circ\text{C}$ | $i_{operating} = 12.1\text{ Amps}$



Specifications

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
Qcmax ($\Delta T = 0$)	117.8 Watts	121.4 Watts	127.7 Watts
ΔT_{max} ($Q_c = 0$)	70.5°C	73.5°C	78.8°C
I_{max} (I @ ΔT_{max})	14.2 Amps	14.2 Amps	14.0 Amps
V_{max} (V @ ΔT_{max})	13.9 Volts	14.4 Volts	15.4 Volts
Module Resistance	0.91 Ohms	0.94 Ohms	1.02 Ohms
Max Operating Temperature	80 °C		
Weight	68.0 gram(s)		

Finishing Options

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
L2	4.572 ±0.013 mm 0.180 ± 0.0005 in	0.013 mm / 0.013 mm 0.0005 in / 0.0005 in	Lapped	Lapped	114.3 mm 4.50 in

Sealing Options

Suffix	Sealant	Color	Temp Range	Description
EP	Epoxy	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

Notes

Max operating temperature: 80°C
Do not exceed I_{max} or V_{max} when operating module
Reference assembly guidelines for recommended installation
Solder tinning also available on metallized ceramics

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Revision: 00 Date: 06-01-2022

Print Date: 05-16-2025